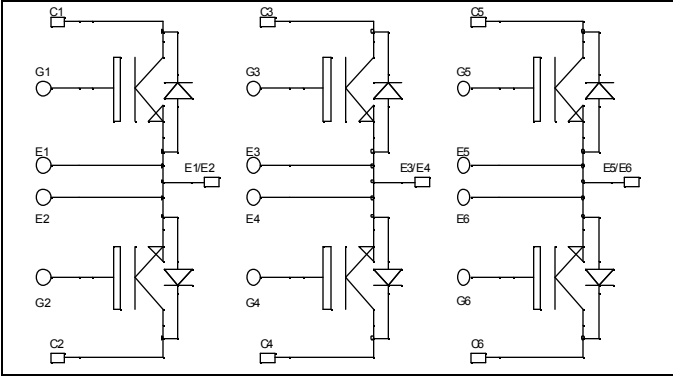


Triple Dual Common Source PT IGBT Power Module

$V_{CES} = 600V$
 $I_C = 50A @ T_c = 80^\circ C$

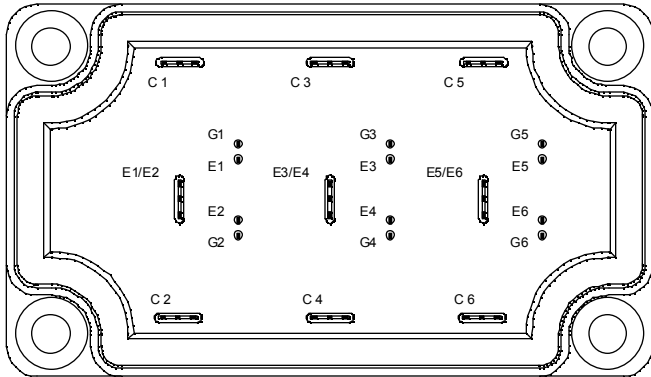


Application

- AC Switches
- Switched Mode Power Supplies
- Uninterruptible Power Supplies

Features

- Power MOS 7[®] Punch Through (PT) IGBT
 - Low conduction loss
 - Ultra fast tail current shutoff
 - Low gate charge
 - Switching frequency capability in the 200kHz range
 - Soft recovery parallel diodes
 - Low diode VF
- Kelvin emitter for easy drive
- Very low stray inductance
 - Symmetrical design
 - Lead frames for power connections
- High level of integration



Benefits

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Solderable terminals both for power and signal for easy PCB mounting
- Very low (12mm) profile
- Each leg can be easily paralleled to achieve a dual common source configuration of three times the current capability

Absolute maximum ratings

Symbol	Parameter	Max ratings	Unit
V_{CES}	Collector - Emitter Breakdown Voltage	600	V
I_C	Continuous Collector Current	$T_c = 25^\circ C$	73
		$T_c = 80^\circ C$	50
I_{CM}	Pulsed Collector Current	$T_c = 25^\circ C$	200
V_{GE}	Gate - Emitter Voltage	± 20	V
P_D	Maximum Power Dissipation	$T_c = 25^\circ C$	227
SSOA	Switching Safe Operating Area	$T_j = 150^\circ C$	190A @ 600V

 **CAUTION:** These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

All ratings @ $T_j = 25^\circ\text{C}$ unless otherwise specified

Electrical Characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
BV_{CES}	Collector - Emitter Breakdown Voltage	$V_{GE} = 0V, I_C = 500\mu A$	600			V
I_{CES}	Zero Gate Voltage Collector Current	$V_{GE} = 0V$			500	μA
		$V_{CE} = 600V$			2500	
$V_{CE(on)}$	Collector Emitter on Voltage	$V_{GE} = 15V$		2.2	2.7	V
		$I_C = 50A$		2.1		
$V_{GE(th)}$	Gate Threshold Voltage	$V_{GE} = V_{CE}, I_C = 1mA$	3		6	V
I_{GES}	Gate - Emitter Leakage Current	$V_{GE} = \pm 20V, V_{CE} = 0V$			± 100	nA

Dynamic Characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
C_{ies}	Input Capacitance	$V_{GE} = 0V$		5700		pF
C_{oes}	Output Capacitance	$V_{CE} = 25V$		465		
C_{res}	Reverse Transfer Capacitance	$f = 1MHz$		30		
Q_g	Total gate Charge	$V_{GE} = 15V$		165		nC
Q_{ge}	Gate - Emitter Charge	$V_{Bus} = 300V$		40		
Q_{gc}	Gate - Collector Charge	$I_C = 50A$		50		
$T_{d(on)}$	Turn-on Delay Time	Inductive Switching (25°C) $V_{GE} = 15V$ $V_{Bus} = 400V$ $I_C = 50A$ $R_G = 5\Omega$		19		ns
T_r	Rise Time			36		
$T_{d(off)}$	Turn-off Delay Time			83		
T_f	Fall Time			60		
E_{on1}	Turn-on Switching Energy			465		
E_{on2}	Turn-on Switching Energy ❶		837		μJ	
E_{off}	Turn-off Switching Energy ❷		637			
$T_{d(on)}$	Turn-on Delay Time	Inductive Switching (125°C) $V_{GE} = 15V$ $V_{Bus} = 400V$ $I_C = 50A$ $R_G = 5\Omega$		19		ns
T_r	Rise Time			36		
$T_{d(off)}$	Turn-off Delay Time			116		
T_f	Fall Time			86		
E_{on1}	Turn-on Switching Energy			465		μJ
E_{on2}	Turn-on Switching Energy ❶			1261		
E_{off}	Turn-off Switching Energy ❷			1058		

❶ E_{on2} includes diode reverse recovery

❷ In accordance with JEDEC standard JESD24-1

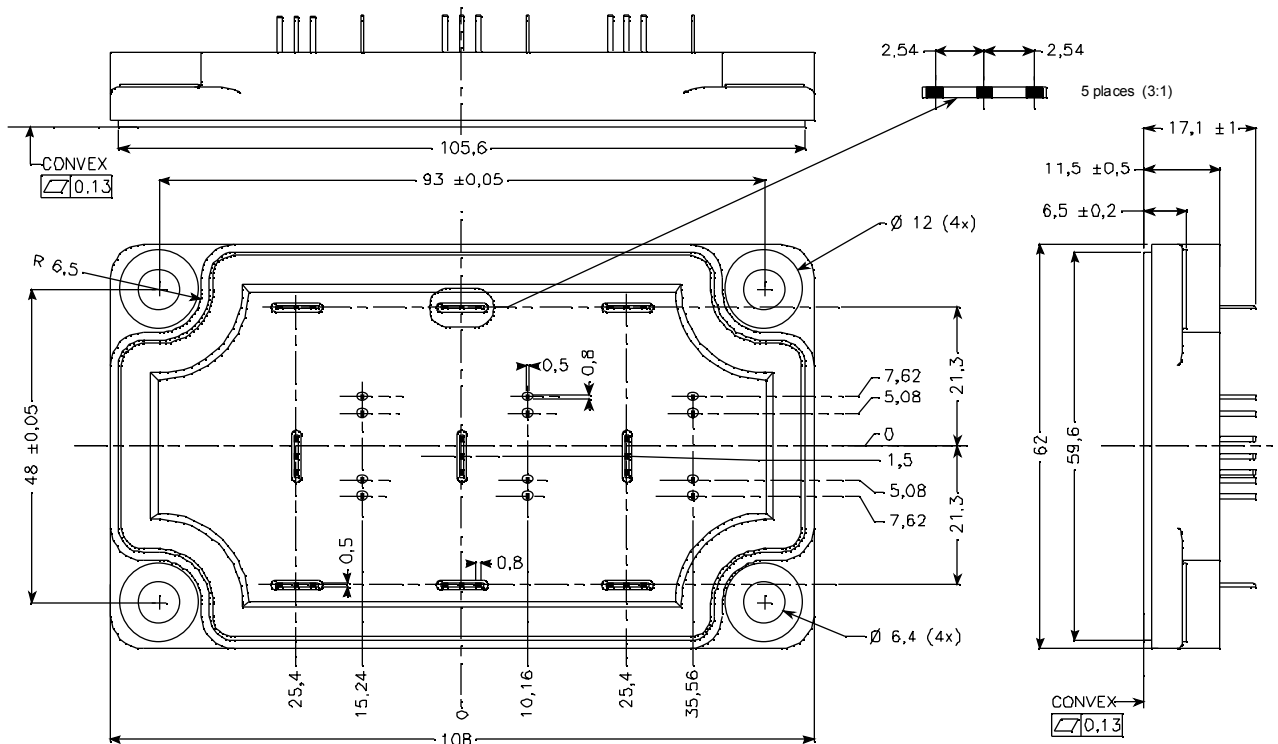
Diode ratings and characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
V _{RRM}	Maximum Peak Repetitive Reverse Voltage			600			V
I _{RM}	Maximum Reverse Leakage Current	V _R =600V	T _j = 25°C			250	µA
			T _j = 125°C			750	
I _{F(AV)}	Maximum Average Forward Current	50% duty cycle	T _c = 70°C		60		A
V _F	Diode Forward Voltage	I _F = 60A			2.2	2.7	V
		I _F = 120A			2.3		
		I _F = 60A	T _j = 125°C		1.4		
t _{rr}	Reverse Recovery Time	I _F = 60A V _R = 400V di/dt=200A/µs	T _j = 25°C		55		ns
			T _j = 125°C		151		
Q _{rr}	Reverse Recovery Charge		T _j = 25°C		121		
		T _j = 125°C		999			

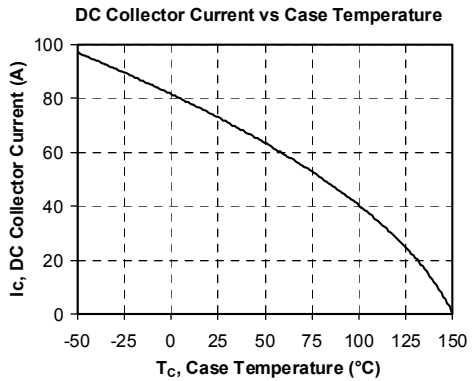
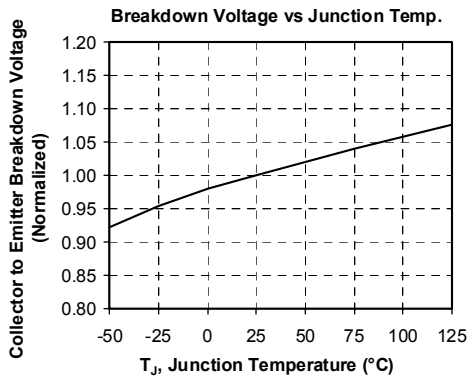
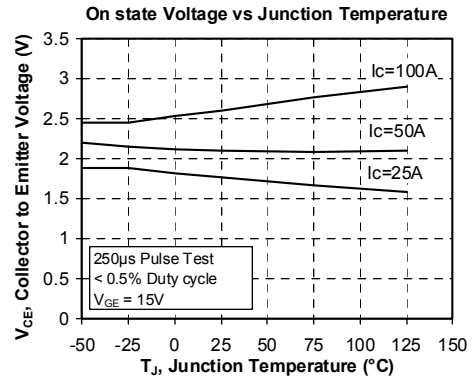
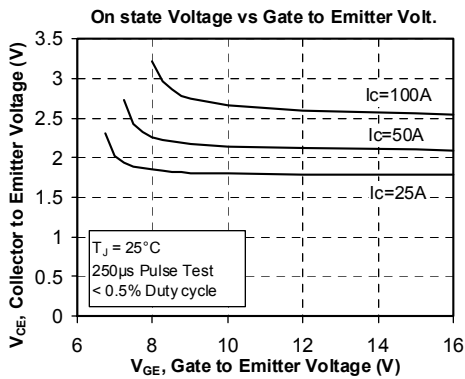
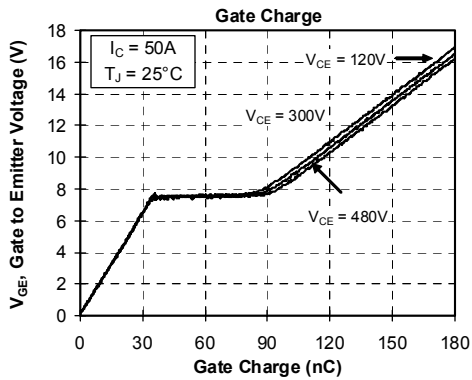
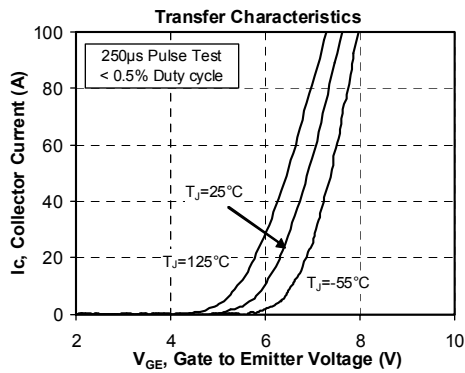
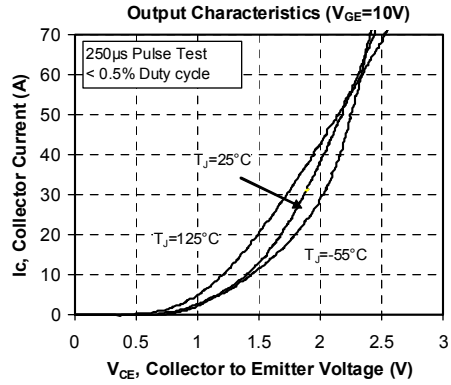
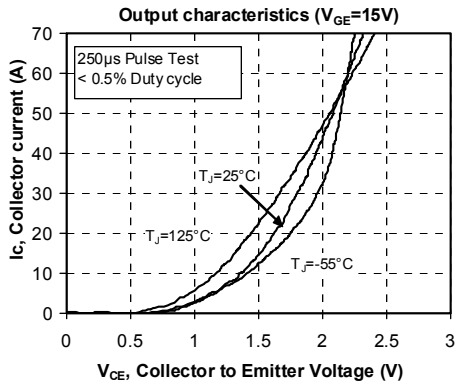
Thermal and package characteristics

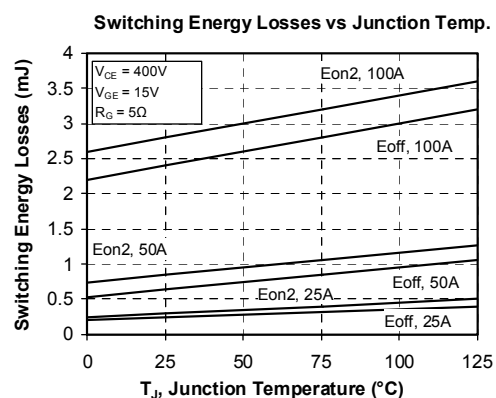
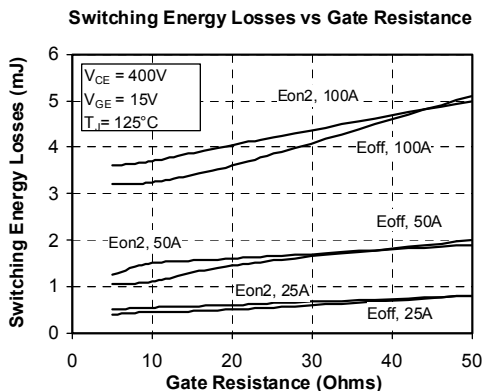
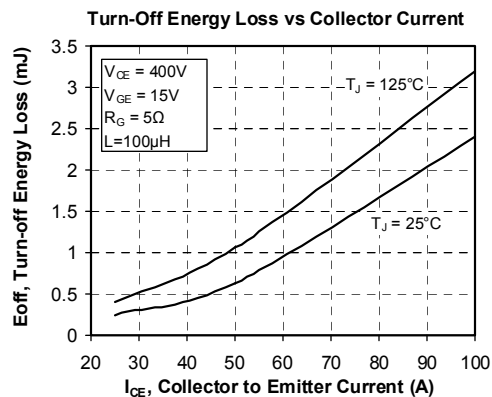
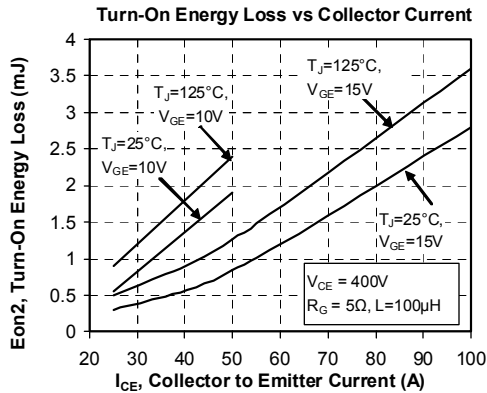
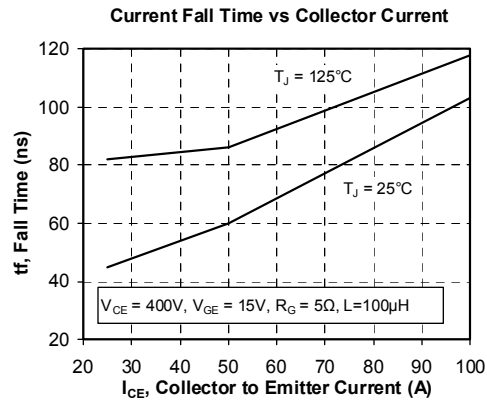
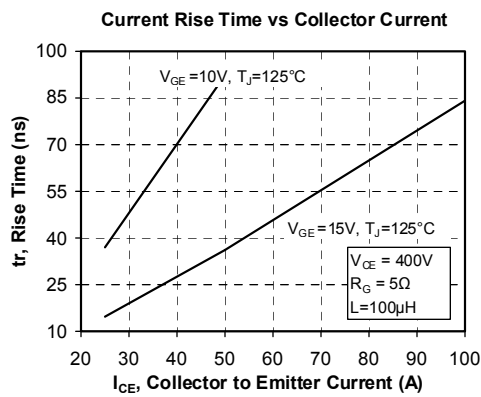
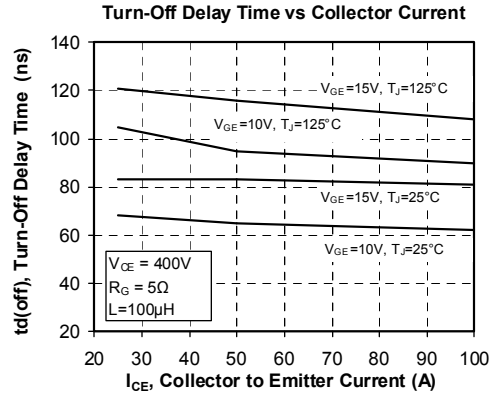
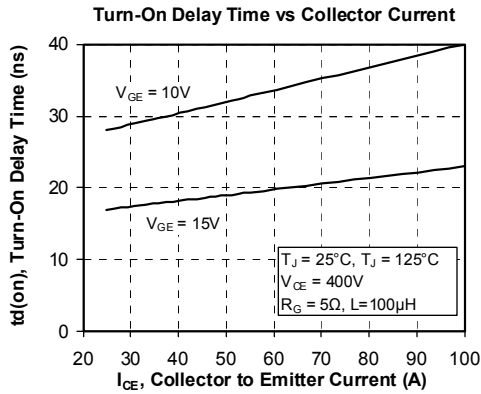
Symbol	Characteristic			Min	Typ	Max	Unit
R _{thJC}	Junction to Case	IGBT				0.55	°C/W
		Diode				0.9	
V _{ISOL}	RMS Isolation Voltage, any terminal to case t=1 min, I _{isol} <1mA, 50/60Hz			2500			V
T _J	Operating junction temperature range			-40		150	°C
T _{STG}	Storage Temperature Range			-40		125	
T _C	Operating Case Temperature			-40		100	
Torque	Mounting torque	To heatsink	M6	3		5	N.m
Wt	Package Weight					250	g

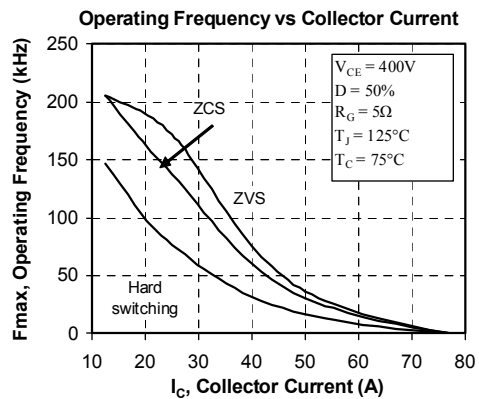
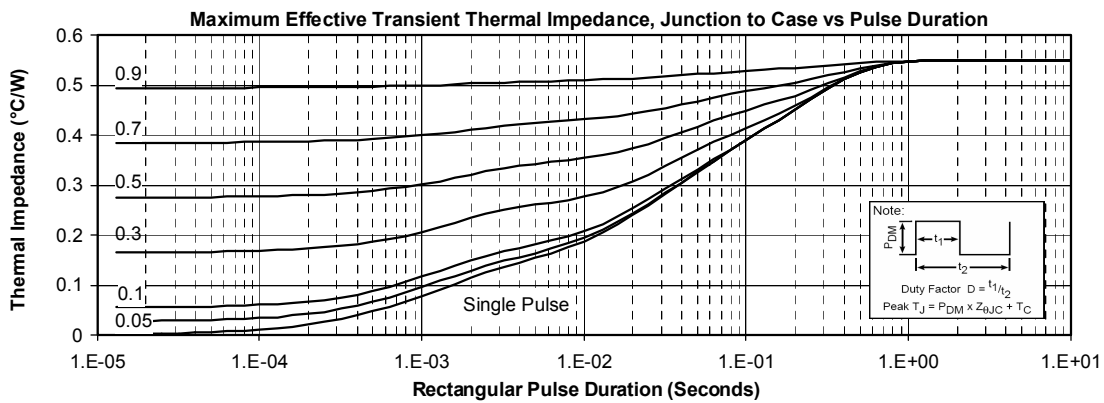
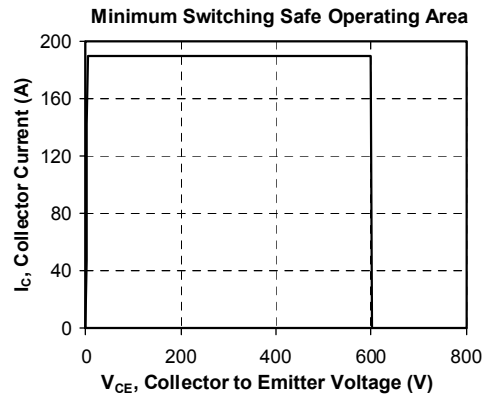
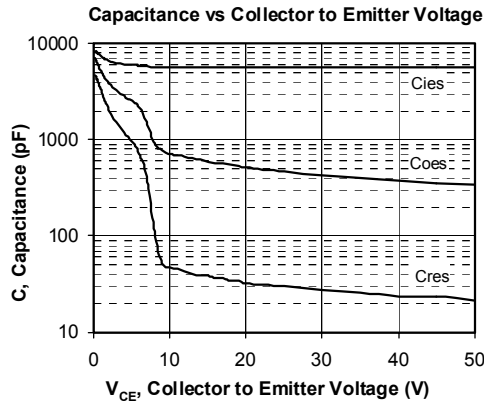
Package outline



Typical Performance Curve







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APT's products are covered by one or more of U.S. patents 4,895,810 5,045,903 5,089,434 5,182,234 5,019,522 5,262,336 6,503,786 5,256,583 4,748,103 5,283,202 5,231,474 5,434,095 5,528,058 and foreign patents. U.S. and Foreign patents pending. All Rights Reserved.